

MDU1721VRH

Single N-channel Trench MOSFET 40V, 100A, 1.4mΩ

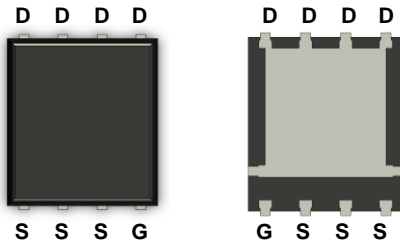
MDU1721VRH – Single N-Channel Trench MOSFET 40V

General Description

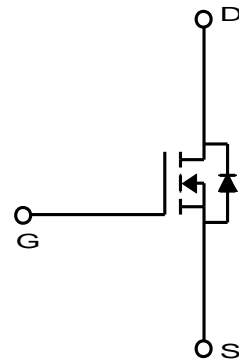
The MDU1721VRH uses advanced MagnaChip's MOSFET Technology, which provides high performance in on-state resistance, fast switching performance and excellent quality. MDU1721VRH is suitable device for Synchronous Rectification For Server and general purpose applications.

Features

- $V_{DS} = 40V$
- $I_D = 100A @ V_{GS} = 10V$
- $R_{DS(ON)} < 1.4m\Omega @ V_{GS} = 10V$
- 100% UIL Tested
- 100% Rg Tested



PDFN56



Absolute Maximum Ratings (Ta = 25°C)

Characteristics		Symbol	Rating	Unit
Drain-Source Voltage		V_{DSS}	40	V
Gate-Source Voltage		V_{GSS}	±20	V
Continuous Drain Current ⁽¹⁾	$T_C=25^\circ C$ (Silicon Limited)	I_D	204.1	A
	$T_C=25^\circ C$ (Package Limited)		100.0	
	$T_C=100^\circ C$		129.1	
	$T_A=25^\circ C^{(3)}$		32.9 ⁽³⁾	
Pulsed Drain Current		I_{DM}	400.0	
Power Dissipation	$T_C=25^\circ C$	P_D	96.2	W
	$T_C=100^\circ C$		38.5	
	$T_A=25^\circ C^{(3)}$		2.5 ⁽³⁾	
Single Pulse Avalanche Energy ⁽²⁾		E_{AS}	450	mJ
Junction and Storage Temperature Range		T_J, T_{stg}	-55~150	°C

Thermal Characteristics

Characteristics	Symbol	Rating	Unit
Thermal Resistance, Junction-to-Ambient ⁽¹⁾	$R_{\theta JA}$	50	°C/W
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	1.3	

Ordering Information

Part Number	Temp. Range	Package	Packing	RoHS Status
MDU1721VRH	-55~150°C	PDFN56	Tape & Reel	Halogen Free

Electrical Characteristics (T_J =25°C)

Characteristics	Symbol	Test Condition	Min	Typ	Max	Unit
Static Characteristics						
Drain-Source Breakdown Voltage	BV _{DSS}	I _D = 250μA, V _{GS} = 0V	40	-	-	V
Gate Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = 250μA	1.0	-	3.0	
Drain Cut-Off Current	I _{DSS}	V _{DS} = 40V, V _{GS} = 0V	-	-	1.0	μA
Gate Leakage Current	I _{GSS}	V _{GS} = ±20V, V _{DS} = 0V	-	-	±0.1	
Drain-Source ON Resistance	R _{DS(ON)}	V _{GS} = 10V, I _D =50A	-	1.1	1.4	mΩ
Forward Transconductance	g _{fs}	V _{DS} = 10V, I _D =50A	-	120	-	S
Dynamic Characteristics						
Total Gate Charge	Q _{g(10.0V)}	V _{DS} = 20.0V, I _D = 50.0A, V _{GS} = 10V	-	113.8	-	nC
Gate-Source Charge	Q _{gs}		-	23.3	-	
Gate-Drain Charge	Q _{gd}		-	18.6	-	
Input Capacitance	C _{iss}	V _{DS} = 20.0V, V _{GS} = 0V, f = 1.0MHz	-	7,450	-	pF
Reverse Transfer Capacitance	C _{rss}		-	200	-	
Output Capacitance	C _{oss}		-	1.850	-	
Turn-On Delay Time	t _{d(on)}	V _{GS} = 10V, V _{DS} = 20.0V, I _D = 50A , R _G = 3.0Ω	-	24.0	-	ns
Rise Time	t _r		-	16.1	-	
Turn-Off Delay Time	t _{d(off)}		-	92.3	-	
Fall Time	t _f		-	30.0	-	
Gate Resistance	R _g	f=1 MHz	-	1.3	-	Ω
Drain-Source Body Diode Characteristics						
Source-Drain Diode Forward Voltage	V _{SD}	I _S = 50A, V _{GS} = 0V	-	0.80	1.2	V
Body Diode Reverse Recovery Time	t _{rr}	I _F =50A, dI/dt = 100A/μs	-	61.0	-	ns
Body Diode Reverse Recovery Charge	Q _{rr}		-	92.0	-	nC

Note :

- Surface mounted FR-4 board by JEDEC (jesd51-7). Continuous current at T_C=25°C is silicon limited
- E_{AS} is tested at starting T_J = 25°C, L = 1.0mH, I_{AS} = 30.0A, V_{GS} = 10V.
- T < 10sec.

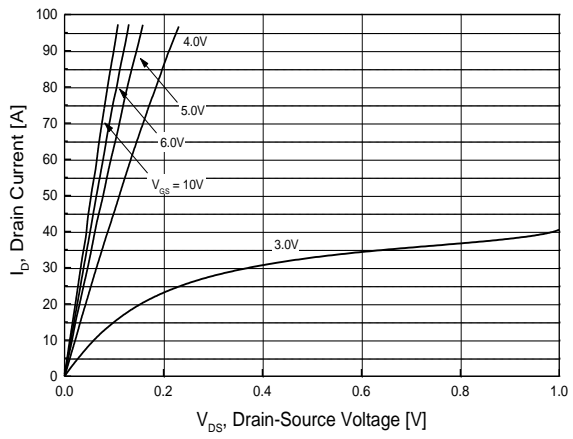


Fig.1 On-Region Characteristics

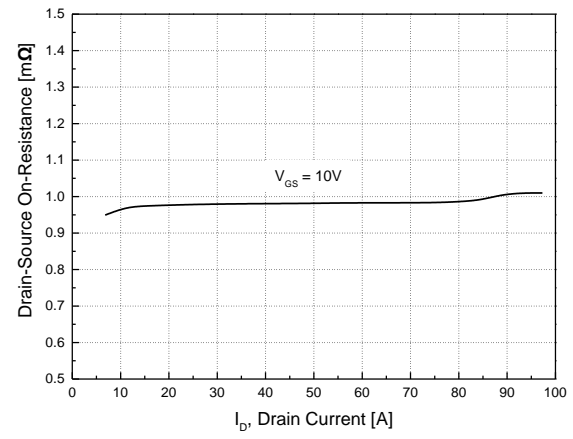


Fig.2 On-Resistance Variation with Drain Current and Gate Voltage

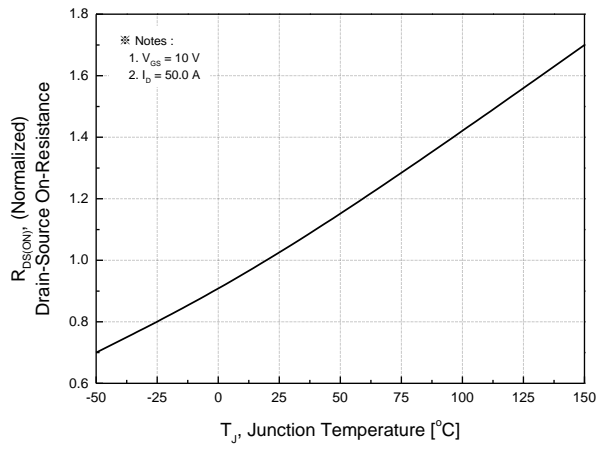


Fig.3 On-Resistance Variation with Temperature

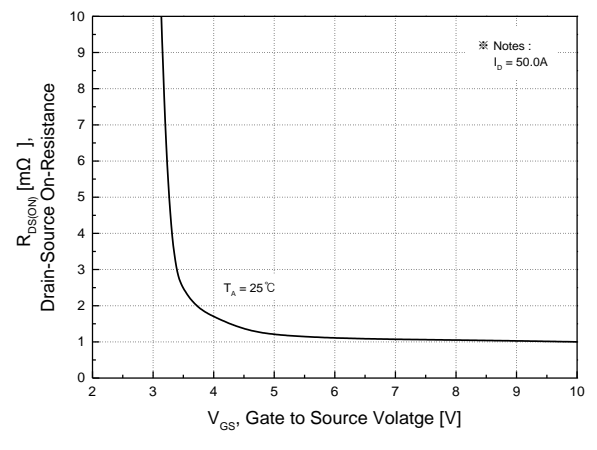


Fig.4 On-Resistance Variation with Gate to Source Voltage

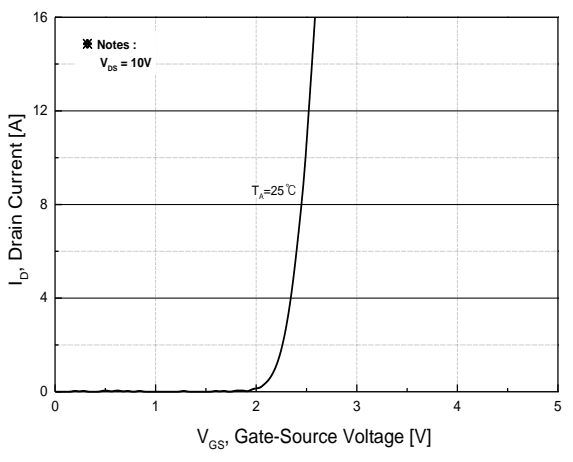


Fig.5 Transfer Characteristics

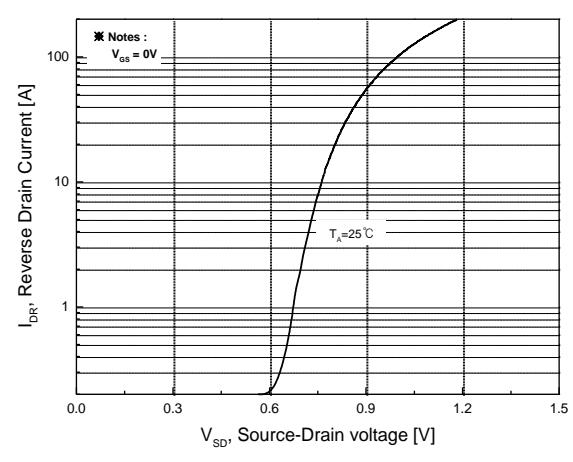
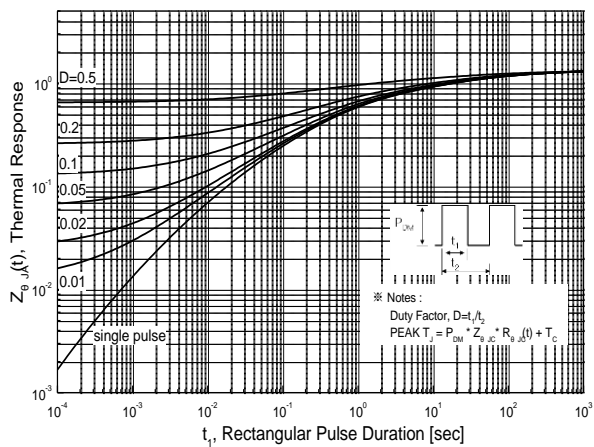
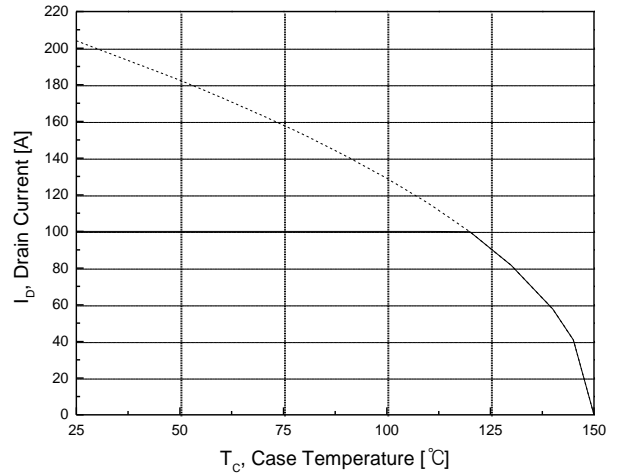
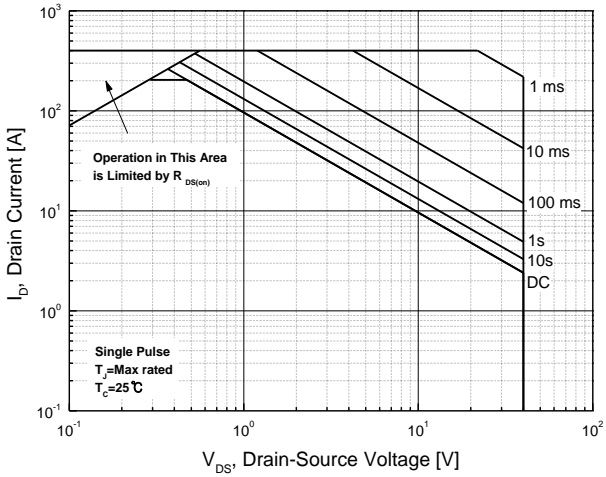
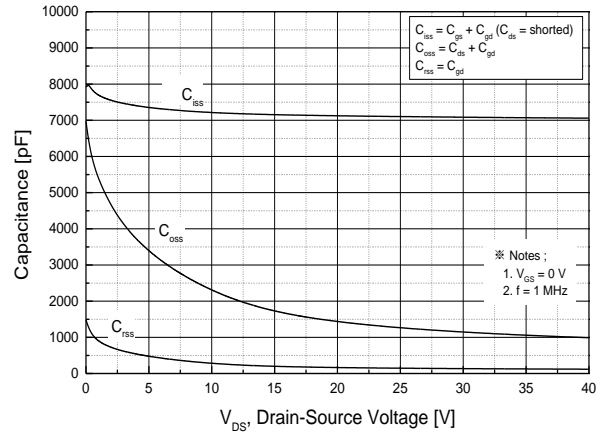
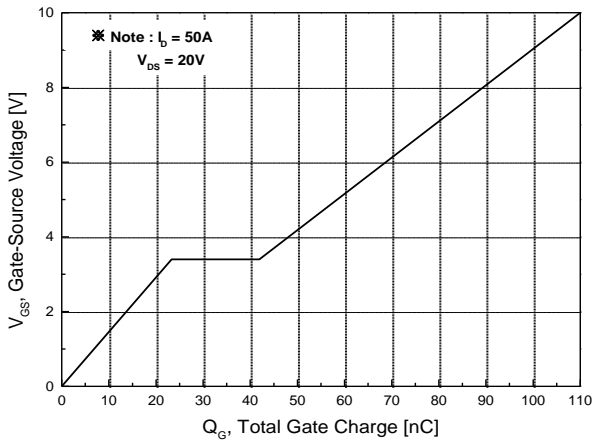


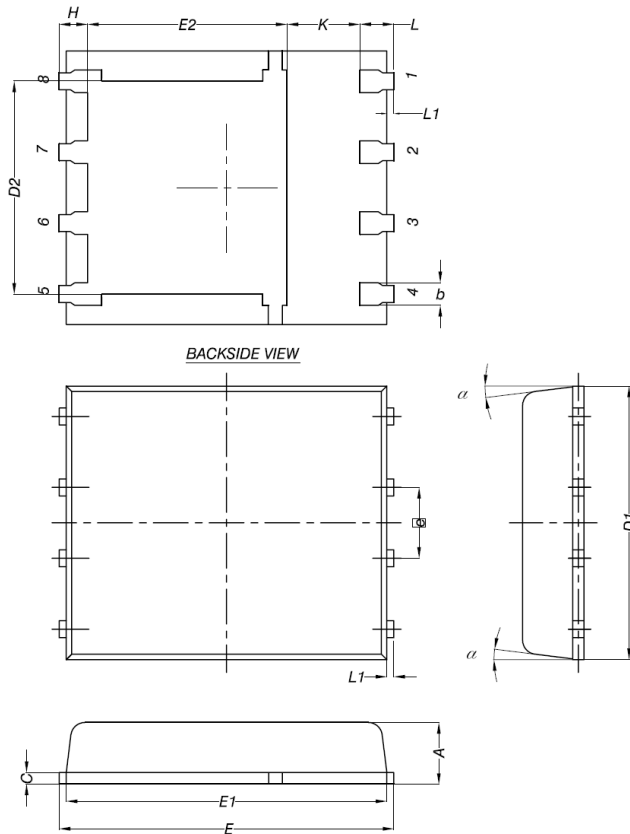
Fig.6 Body Diode Forward Voltage Variation with Source Current and Temperature



Package Dimension

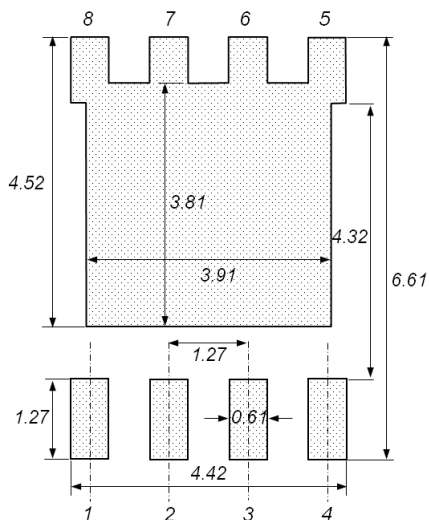
PDFN56 (5x6mm)

Dimensions are in millimeters, unless otherwise specified



Dimension	MILLIMETERS [mm]	
	Min	Max
A	0.90	1.10
b	0.33	0.51
C	0.20	0.34
D1	4.50	5.10
D2	-	4.22
E	5.90	6.30
E1	5.50	6.10
E2	-	4.30
e	1.27BSC	
H	0.41	0.71
K	0.20	-
L	0.51	0.71
L1	0.06	0.20
α	0°	12°

Land Pattern



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